

03-24-2005

US Department Of Commerce
Patent & Trademark Office



102966220

03-11-05

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): **Walton FONG
Remmelt PIT
Mike SUK**

2. Name and address of receiving party(ies):
Name: **Hitachi Global Storage Technologies
Netherlands B.V.**
Street Address:
**Locatellikade 1
Parnassustoren
1076 AZ Amsterdam
The Netherlands**

112948 U.S. PTO
11/077880
031105

Additional name(s) of conveying party(ies) attached Yes No

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:
XX Assignment Execution Date: **03/08/2005, 03/08/2005, 03/08/2005**

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: **03/11/2005**
A. Patent Application No.(s) B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: **Wagner, Murabito & Hao LLP**
Attention: **John P. Wagner, Jr.**
Street
Address: **2 N. Market Street, Suite 300
San Jose, California 95113**

6. Total Number of applications and patents involved: **One**

7. Total fee (37 CFR 3.41).....\$ **40.00**
 Enclosed
 Authorized to be charged to deposit account

8. Deposit Account Number: **50-2587**

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

John P. Wagner, Jr. 03/11/2005
Date

Total number of pages including cover sheet, attachments, and document: / 3 /

03/23/2005 6TON11 00000076 502587 11077880
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ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

- (1) **Walton FONG, San Jose, CA**
- (2) **Remmelt PIT, Cupertino, CA**
- (3) **Mike SUK, San Jose, CA**

have invented certain improvements in

TITLE

METHOD AND APPARATUS FOR REDUCING A SUSPENSION GRAM LOAD TO INCREASE HEAD TO DISK INTERFACE RELIABILITY FOR CONTACT RECORDING SYSTEMS

DATES THAT
INVENTORS
SIGNED

and executed, respectively, a United States patent application therefore on

- (1) 3/6/2005
- (2) 03/08/05
- (3) 3/8

Whereas, **HITACHI GLOBAL STORAGE TECHNOLOGIES NETHERLANDS B.V.**, having a place of business at Locatellikade 1, Parnassustoren, 1076 AZ Amsterdam, The Netherlands (hereinafter called HITACHI), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to HITACHI, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HITACHI, its successors and assigns; and we hereby agree that HITACHI may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HITACHI.

Signed

CITY
DATE


(1) at San Jose
on March 8, 2005,



Walton FONG SIGNATURE

CITY
DATE

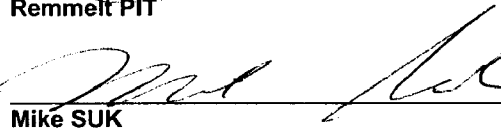
(2) at San Jose
on 03/08, 2005,



Remmelt PIT SIGNATURE

CITY
DATE

(3) at San Jose
on 3/8, 2005,



Mike SUK SIGNATURE